

[0076] The use of parallel polled bimorph reeds in combination with bimorph clip 30 eliminates the prior art need for sixteen (16) wires and thirty-two (32) hand-solder joints per Braille cell assembly. The parallel polled bimorph reed design also results in an estimated fifty percent (50%) power reduction by reducing the operating voltage and the mechanical resistance presented by the prior art construction.

[0077] Note that each bimorph actuator is mechanically held at its fulcrum by metal contacts on the PCB. These contacts also provide an electrical connection for biasing the bimorph actuator. This novel structure is an improvement over the above-mentioned prior art structures that hold the bimorph in a mechanical frame formed of non-conductive plastic and which require the soldering of sixteen (16) wires and thirty-two (32) hand-soldered connections per cell. The new cell eliminates all wires and thus all of the thirty two (32) hand-soldered connections. Only the center conductor is soldered by hand in the novel design. This solder connection is completed in the constraints of alignment fixture to accurately control the position of the work end of the bimorph.

[0078] Bimorph clip 30 may be thought of as a split clip or an isolated clip because the contact on the top of the bimorph is electrically isolated from the contact on the bottom of the bimorph. In another embodiment of clip 30, known as a common clip, not deemed currently suitable for use in a commercial embodiment of the invention, the top of the bimorph is mechanically and electrically connected to the bottom of the bimorph. Although functional, the effects of long-term aging of the ceramic in the bimorph are unacceptable. In this common clip, both halves of the bimorph work in concert with one another but untested piezo material properties, specifically the aging effect of reverse-biasing the ceramic material, require further investigation. Half the high voltage, or 100 volts, was applied to the center of the common clip. This center voltage, or bimorph virtual ground, enables the use of standard high voltage drive circuitry and a common clip. The common clip may become viable as advances are made in piezo-ceramic technology.

[0079] The serviceability of each novel bimorph is maintained and improved over other designs. If an individual Braille dot does not meet specification, that Braille cell is removed and the bad bimorph removed by reflowing a single solder joint. The replacement bimorph is then inserted into the Braille cell PCB and aligned with the aid of a fixture. This avoids the problem in removing prior art bimorphs where individual bimorph removal is complicated by the attachment of two (2) wires to each bimorph.

[0080] FIG. 4A depicts a Braille cell assembly 40 mounted on top wall 44 of a chassis/backplane not depicted in this figure and FIG. 4B depicts a plurality of said Braille cell assemblies mounted on said top wall. Braille cell assembly 40 includes PCB 36 to which is soldered a plurality of novel bimorph clips 30 in vertically spaced relation to one another during standard SMT processing. A bimorph reed 20 is then inserted between biased arms 32, 34 of each clip 30 using an alignment jig. Each center conductor 26 of each bimorph reed 20 is then soldered to PCB 36. This process eliminates the need for sixteen (16) hand-soldered jumper wires. It also eliminates the prior art need for providing plating on bimorph reed 20 to enable said bimorph reed to accept solder.

[0081] A plurality of PCB-receiving sockets 42 is mounted on top wall 44 in spaced relation to one another as depicted. A large number of Braille cell assemblies 40 may therefore be mounted to said top wall as suggested by FIG. 4B.

[0082] FIG. 5 discloses the pin connections of Braille device interface 50. Interface 50 defines the required connections to drive the display. This embodiment enables left or right side connections and further enables independent scanning of key switches without changing latched display data.

[0083] FIGS. 6A and 6B are perspective views of opposite sides of Braille cell assembly 40. The disclosure of these FIGS. 6A and 6B is essentially the same as the disclosure of FIGS. 4A and 4B but FIGS. 6A and 6B make it clearer that clips 30 and bimorph reeds 20 are mounted on both sides of PCB 36. Note that there are four (4) bimorph reeds 20 mounted on each side of PCB 36 so that there are eight (8) bimorph reeds mounted on each PCB 36. Accordingly, it should be understood that each PCB is dedicated to a Braille cell having eight (8) Braille pins and each bimorph reed is dedicated to a Braille pin of said Braille cell.

[0084] FIG. 7A is a top perspective view of chassis/backplane 60 and FIG. 7B is a bottom perspective view thereof. Chassis/backplane 60 includes top wall 44 (see FIGS. 4A and 4B) and bottom wall 46. It also includes an angle wall 62 having a plurality of sets 64 of pinholes or bores 66 formed in a horizontal part 62a thereof. Horizontal part 62a of angle wall 62 abuts a leading edge of top wall 44 and is coplanar therewith. Each pinhole or bore 66 is adapted to slideably receive a pin, not depicted in FIGS. 7A and 7B. Note that there are eight (8) pinholes or bores 66 per set 64 of pinholes or bores.

[0085] Upstanding flat wall 68 abuts a trailing edge of top wall 44 and a trailing edge of bottom wall 46. A plurality of slots 70 is formed in the lower edge of said flat wall 68. Each slot engages a protuberance 36a formed in the trailing end of its associated PCB. A corresponding plurality of slots 72 is formed in top wall 44 to accommodate the respective leading ends of the PCBs. Each set of slots 70 and 72 cooperate with one another to provide a mount for each PCB 36.

[0086] FIG. 8A depicts chassis/backplane 60 when a PCB 36 is mounted in each slot 70 and 72. It also depicts a Braille pin 80 disposed in each pinhole or bore 66. One (1) bimorph reed 20 is associated with each pin 80, there being one PCB 36 having eight (8) bimorph reeds mounted thereto associated with each set 64 of eight (8) pinholes or bores 66 as aforesaid.

[0087] Pins 80 are provided in four differing lengths as indicated in FIG. 8B. The pins may be manufactured individually, or they may be manufactured in connected-together groups of eight (8) that are separated from one another after assembly into the Braille cell, thereby improving manufacturability.

[0088] Each pin 80 has a solid or hollow construction and includes four (4) parts that share a common longitudinal axis of symmetry. Each of the four (4) parts may have a transverse cross-section of any predetermined geometrical configuration. A more detailed description of the pins is provided in U.S. patent application Ser. No. 10/710,808, filed Aug. 4, 2004 by the same inventors. That patent application is hereby incorporated by reference into this disclosure.

[0089] The novel cell cap of this invention is depicted in FIGS. 9A and 9B and is denoted as a whole by the reference numeral 90. Twenty (20) sets 92 of pinholes 94 are depicted, each pinhole being adapted to slidably receive tip 80d of pin 80. This configuration is referred to as a "double decade" and represents one (1) module. Unlike the aforementioned prior art Braille cells that require one individual cap per set of pinholes, cell cap 90 is a monolithic cap for all sets of pinholes, i.e., cell cap enables one cap to cap a plurality of Braille